## 2SD1979

## Silicon NPN epitaxial planar type

For low frequency amplification

For muting

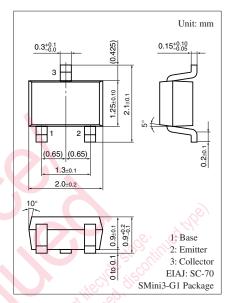
For DC-DC converter

#### ■ Features

- Low ON resistance Ron
- High forward current transfer ratio h<sub>FE</sub>
- S-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit		
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	50	V		
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	V <sub>CEO</sub> 20		CEO 20 V	
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	25	V		
Collector current	$I_{C}$	300	mA		
Peak collector current	$I_{CP}$	500	mA		
Collector power dissipation	P <sub>C</sub>	150	mW		
Junction temperature	$T_{j}$	150	°C		
Storage temperature	$T_{stg}$	-55 to +150	°C		



Marking symbol: 3W

### ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

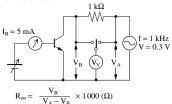
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = 1 \text{ mA}, I_B = 0$	20			V
Base-emitter voltage	$V_{BE}$	$V_{CE} = 2 \text{ V}, I_{C} = 4 \text{ mA}$		0.6		V
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{CB} = 50 \text{ V}, I_{E} = 0$			1	μΑ
Emitter-base cutoff current (Collector open)	$I_{EBO}$	$V_{EB} = 25 \text{ V}, I_{C} = 0$			1	μΑ
Forward current transfer ratio *1	h <sub>FE</sub>	$V_{CE} = 2 \text{ V}, I_{C} = 4 \text{ mA}$	500		2500	_
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 30 \text{ mA}, I_B = 3 \text{ mA}$			0.1	V
Transition frequency	$f_{T}$	$V_{CB} = 6 \text{ V}, I_E = -4 \text{ mA}, f = 200 \text{ MHz}$		80		MHz
Collector output capacitance (Common base, input open circuited)	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		4.5		pF
ON resistance *2	R <sub>on</sub>			1		Ω

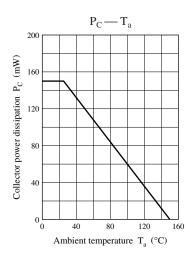
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

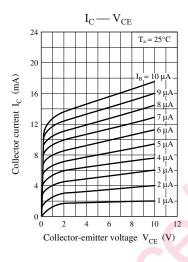
#### 2. \*1: Rank classification

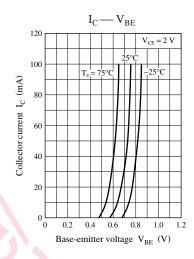
•	Rank	S	Т
	$h_{FE}$	500 to 1 500	800 to 2500

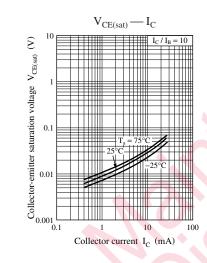
\*2: Ron Measuremet circuit

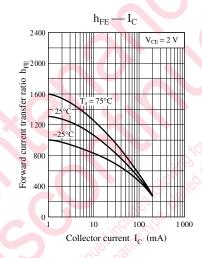


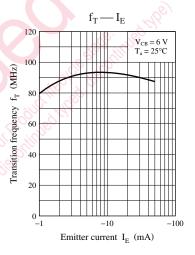


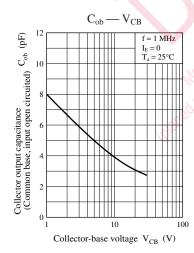












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